

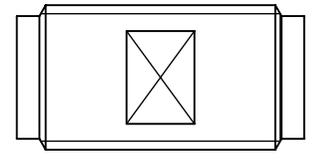
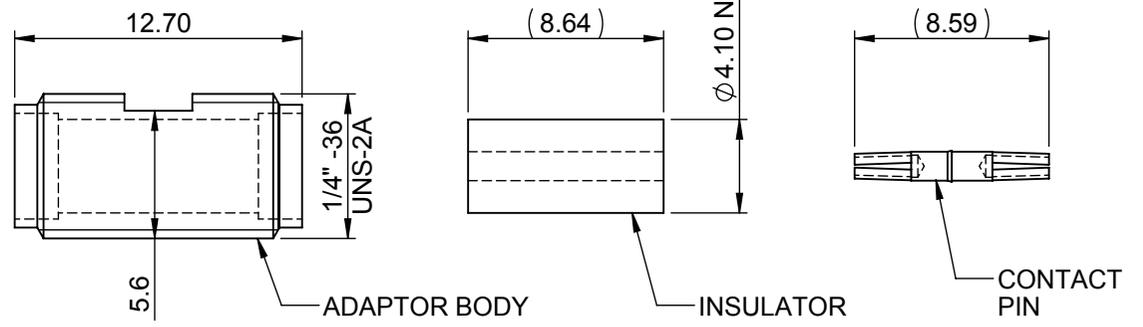
TOLERANCES UNLESS OTHERWISE STATED			
0 DEC. PLACE	±0.5	2 DEC. PLACES	±0.1
1 DEC. PLACE	±0.2	ANGULAR	±1°

A  
B  
C  
D

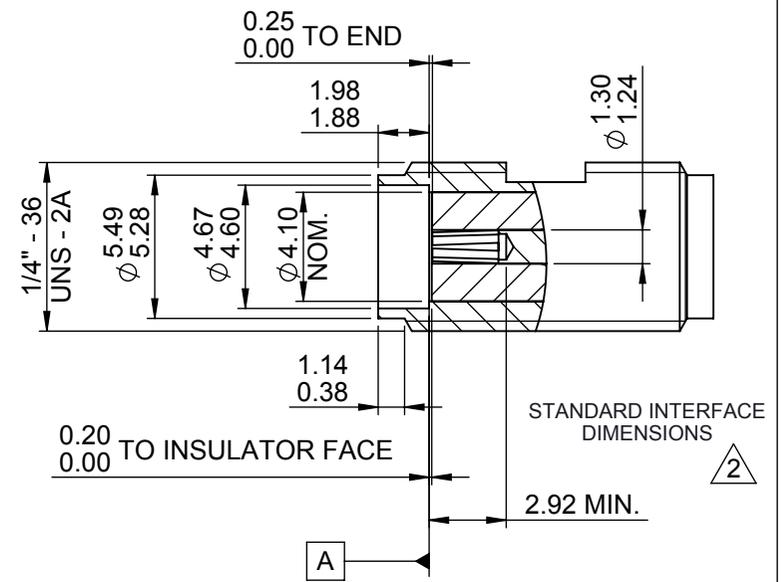
NOTES:



- IMPEDANCE 50Ω.
- CONTACT PIN MUST REMAIN CAPTIVE AFTER ASSEMBLY OF ADAPTOR.
- FINAL ADAPTOR ASSEMBLY MUST CONFORM TO STANDARD INTERFACE DIMENSIONS SHOWN.
- MATERIALS:  
ADAPTOR BODY: BRASS CW603N (CuZn36Pb3), BRASS CW614N (CuZn39Pb3) OR APPROVED EQUIVALENT  
CONTACT PIN: BERYLLIUM COPPER CW101C (CuBe2) OR APPROVED EQUIVALENT  
INSULATOR: PTFE
- FINISH:  
ADAPTOR BODY:  
NICKEL (1.27µm MIN.) OVER COPPER (1.27µm MIN.)  
- FINISHED PLATING THICKNESS 2.5-3.0µm.  
CONTACT PIN:  
GOLD PLATED (0.076µm MIN.) OVER NICKEL (1.27µm MIN.)  
INSULATOR: SMOOTH MACHINED
- ALL THREADS TO BE FREE FROM RESTRICTION ALONG ENTIRE LENGTH AFTER PLATING.
- ALL DIMENSIONS APPLY AFTER PLATING.
- SAMPLES MUST BE APPROVED BY PANORAMA ANTENNAS Q.C. BEFORE COMMENCING PRODUCTION.
- ALL PARTS MUST BE RoHS COMPLIANT AND MUST NOT CONTAIN ANY SUBSTANCES OF VERY HIGH CONCERN (SVHCs) LISTED UNDER REACH OR POLY-AROMATIC HYDROCARBONS (PAHs), OR PERSISTENT ORGANIC POLLUTANTS (POPs) CONTROLLED BY THE STOCKHOLM CONVENTION.
- IN ORDER TO ASSURE COMPLIANCE WITH THE USA DODD-FRANK ACT (SECTION 1502) TIN, GOLD, TANTALUM AND TUNGSTEN CONTAINED IN PANORAMA PRODUCTS MUST BE FULLY TRACEABLE TO A SMELTER APPROVED BY THE CONFLICT-FREE SOURCING INITIATIVE ([www.conflictfreesmelter.org](http://www.conflictfreesmelter.org)).



ISO VIEW  
SCALE 1:1



PRODUCT/ASSEMBLY <b>ADAPTORS</b>		DESCRIPTION <b>SMA (f) - SMA (f) ADAPTOR</b>			
MATERIAL <b>SEE NOTES</b>		APPROVED KD	DO.CHECK KD	SCALE 3:1	DIMENSIONS IN mm
FINISH <b>SEE NOTES</b>					
WEIGHT 1.92g	SHEET 1 OF 1				

01019	2	REDRAWN IN 2D AND 3D. NOTES UPDATED.	13/01/2015	PE
PCN	REV.	DESCRIPTION OF CHANGE	DATE	DRAWN
REVISIONS				